| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>International and P | IPC, Bannockl  | ourn, Illinois. A     | Ill rights reserved untions. | under both       | This docum<br>level parts, t                                      | ent is a declar<br>the declaration | ation of the<br>encompass | substance<br>ses all low   | s within the<br>er level mat | manufacture<br>erials for wh    | er listed ite<br>hich the ma | m. Note:<br>nufacture | if the item is an as<br>er has engineering | ssembly with low responsibility. |
|--|--|-----------------------|------------------------------|------------------|---|------------------------------------|---------------------------|--|------------------------------|---------------------------------|------------------------------|-----------------------|--|----------------------------------|
|  | IPC Web Site for Information on IPC-1752 Standard Form Ty<br>http://www.ipc.org/IPC-175x Distribut |                       |                              |                  | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                                    |                           |  | eous Materia                 | ials and Mfg Information        |                              |                       |  |                                  |
| Supplier Information   |  |                       |                              |                  |   |                                    |                           |  |                              |                                 |                              |                       |  |                                  |
| Company name*  |  |                       | Company unique ID            |                  |   | Unique ID Authority                |                           |  |                              |                                 | Response Date*               |                       |  |                                  |
| onsemi   |  |                       |                              |                  |   |                                    |                           |  |                              |                                 | 2025-08-02                   |                       |  |                                  |
| Contact Name Title - Contact   |  |                       | tact                         |                  |   | Phone - Contact*                   |                           |  |                              | Email - Contact*                |                              |                       |  |                                  |
| Product-Env-Stewards Product 1   |  |                       | oduct Enviro Compliance      |                  |   | NA                                 |                           |  |                              | Product-Env-Stewards@onsemi.com |                              |                       |  |                                  |
| Authorized Representative* Title - Rep                                   |  |                       | - Representative             |                  |   | Phone - Representative*            |                           |  |                              | Email - Representative*         |                              |                       |  |                                  |
| Product-Env-Stewards Produc  |  |                       | Product Enviro Compliance    |                  |   | NA                                 |                           |  |                              | Product-Env-Stewards@onsemi.com |                              |                       |  |                                  |
| Requester Item Number  | Requester Item Number Mfr Item   |                       | n Number Mfr Item Name       |                  |   | Effective Da                       | te Versio                 | Version Manufacturing Site   |                              | W                               | eight*                       | UOM                   | Unit Type                                  |                                  |
|  | MC74L  | MC74LVX86DR2G LOG CMO |                              | S GATE EXCLSV OR |   | 2025-08-02                         |                           |  | PH1                          |                                 | 12                           | 2.05                  | mg   | Each                             |
| Aanufacturing Proccess Inform  | ation  |                       |                              |                  |   |                                    |                           |  |                              |                                 |                              |                       |  |                                  |
| Terminal Plating / Grid Array Material Terminal Base Alloy               |  |                       | Alloy                        | J-STD-020 MS     | L Rating  | Peak Pro                           | cess Body                 | ody Temperature Max Time at Peak Temperature Number of Reflow Cycles |                              |                                 |                              |                       | cles                                       |                                  |
| Matte Tin (Sn) - annealed CU Alloy                                       |  |                       |                              | 1                |   | 260                                |                           | С  | 30                           |                                 | second                       | 3                     |  |                                  |
| omments  |  |                       |                              |                  |   |                                    |                           |  |                              |                                 |                              |                       |  |                                  |
| vel 1 - maximum time at peak tempera                                     | ture during so   | Idering is 10-3       | 0 seconds                    |                  |   |                                    |                           |  |                              |                                 |                              |                       |  |                                  |
| or more information regarding materia                                    | al composition   | please refer to       | page 3                       |                  |   |                                    |                           |  |                              |                                 |                              |                       |  |                                  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).  |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and co<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |                     |                  |        |         |                 |  |  |
|--|--------|-----------------|----------|---------------------|------------------|--------|---------|-----------------|--|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance           | CAS              | Exempt | Weight  | Unit of Measure |  |  |
| Die  | 0.98   | mg              | Supplier | Silicon (Si)        | 7440-21-3        |        | 0.98    | mg              |  |  |
| Die Attach   | 4.44   | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 3.33    | mg              |  |  |
|  |        |                 | Supplier | Epoxy resins        | 129915-35-1      |        | 1.11    | mg              |  |  |
| Lead Frame   | 69.62  | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.7658  | mg              |  |  |
|  |        |                 | Supplier | Zinc (Zn)           | 7440-66-6        |        | 0.1392  | mg              |  |  |
|  |        |                 | Supplier | Iron (Fe)           | 7439-89-6        |        | 1.8101  | mg              |  |  |
|  |        |                 | Supplier | Copper (Cu)         | 7440-50-8        |        | 66.9048 | mg              |  |  |
| Mold Compound-Black                                  | 43.43  | mg              |          | Epoxy Phenol Resin  | proprietary data |        | 4.5601  | mg              |  |  |
|  |        |                 | Supplier | Fused Silica (SiO2) | 60676-86-0       |        | 38.8699 | mg              |  |  |
| Plating  | 3.27   | mg              | Supplier | Tin (Sn)            | 7440-31-5        |        | 3.27    | mg              |  |  |
| Wire Bond - Au                                       | 0.31   | mg              | Supplier | Gold (Au)           | 7440-57-5        |        | 0.31    | mg              |  |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted)